

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT										
NATURE OF CONVEYANCE:	Corrective Assignment to correct the spelling of the third listed Assignee previously recorded on Reel 022323 Frame 0450. Assignor(s) hereby confirms the assignment to Sanyo Electric Co., Ltd., Sanyo Semiconductor Co., Ltd., and Sanyo Semiconductor Manufacturing Co., Ltd..										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Akira SUZUKI</td><td>02/18/2009</td></tr><tr><td>Katsuyuki SEKI</td><td>02/16/2009</td></tr><tr><td>Keita ODAJIMA</td><td>02/17/2009</td></tr></tbody></table>		Name	Execution Date	Akira SUZUKI	02/18/2009	Katsuyuki SEKI	02/16/2009	Keita ODAJIMA	02/17/2009		
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<table border="1"><tr><td>Name:</td><td>Sanyo Electric Co., Ltd.</td></tr><tr><td>Street Address:</td><td>2-5-5, Keihanondori</td></tr><tr><td>City:</td><td>Moriguchi-shi, Osaka</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>570-8677</td></tr></table>		Name:	Sanyo Electric Co., Ltd.	Street Address:	2-5-5, Keihanondori	City:	Moriguchi-shi, Osaka	State/Country:	JAPAN	Postal Code:	570-8677
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<table border="1"><tr><td>Name:</td><td>Sanyo Semiconductor Co., Ltd.</td></tr><tr><td>Street Address:</td><td>1-1-1, Sakata, Oizumi-Machi,</td></tr><tr><td>City:</td><td>Ora-Gun, Gunma</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>370-0596</td></tr></table>		Name:	Sanyo Semiconductor Co., Ltd.	Street Address:	1-1-1, Sakata, Oizumi-Machi,	City:	Ora-Gun, Gunma	State/Country:	JAPAN	Postal Code:	370-0596
Name:	Sanyo Semiconductor Co., Ltd.										
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<table border="1"><tr><td>Name:</td><td>Sanyo Semiconductor Manufacturing Co., Ltd.</td></tr><tr><td>Street Address:</td><td>Koh 3000, Chiya</td></tr><tr><td>City:</td><td>Ojiya-shi, Niigata</td></tr><tr><td>State/Country:</td><td>JAPAN</td></tr><tr><td>Postal Code:</td><td>947-8502</td></tr></table>		Name:	Sanyo Semiconductor Manufacturing Co., Ltd.	Street Address:	Koh 3000, Chiya	City:	Ojiya-shi, Niigata	State/Country:	JAPAN	Postal Code:	947-8502
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Street Address:	Koh 3000, Chiya										
City:	Ojiya-shi, Niigata										
State/Country:	JAPAN										
Postal Code:	947-8502										
PROPERTY NUMBERS Total: 1											
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CH \$40.00 12338686

PATENT

500798735

REEL: 022351 FRAME: 0418

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:

606402046500

NAME OF SUBMITTER:

Christopher W. Ferguson

Total Attachments: 8

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## PATENT ASSIGNMENT

Electronic Version v1.1  
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02/27/2009  
500793241

SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

## CONVEYING PARTY DATA

Name	Execution Date
Akira SUZUKI	02/18/2009
Katsuyuki SEKI	02/16/2009
Keita ODAJIMA	02/17/2009

## RECEIVING PARTY DATA

Name:	SANYO Electric Co., Ltd.
Street Address:	2-5-5 Kelhanhondori
City:	Moriguchi-shi, Osaka
State/Country:	JAPAN
Postal Code:	570-8677

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Postal Code:	947-8502

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12338686

## CORRESPONDENCE DATA

CH \$40.00 12338686

D:AMIR R. ROHANI COMPANY:(C) MORRISON AND FOERSTER LLI

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*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*

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Address Line 4: McLean, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:

606402046500

NAME OF SUBMITTER:

Amir R. Rohani

Total Attachments: 2

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**MORRISON & FOERSTER LLP**

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assigns, transfers and sets over to:

**SANYO Electric Co., Ltd.  
2-5-5, Keihanhondori  
Moriguchi-shi, Osaka 570-8677 Japan**

**And**

**SANYO Semiconductor Co., Ltd.  
1-1-1, Sakata, Oizumi-Machi, Ora-Gun  
Gunma 370-0596 Japan**

**And**

**SANYO Semiconductor Manufacturing Co., Ltd.  
Koh 3000, Chiya, Ojiya-shi  
Niigata 947-8502 Japan**

(hereinafter designated as the "ASSIGNEES"), its successors and assigns, the entire right, title, and interest for the United States in the invention, and all applications for patent and any Letters Patent which may be granted therefore, including said application, and all United States Letters Patent which may be granted thereof, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of said Letters Patent when granted to be held by said ASSIGNEES, its successors, assigns or their legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been and enjoyed by Assignors if this assignment had not been made, the application being known by the title:

**MESA SEMICONDUCTOR DEVICE AND METHOD OF  
MANUFACTURING THE SAME**

Attorney Docket No.: 60640-20465.00

for which the undersigned has/have executed an application for patent in the United States of America on the same day herewith. Where this instrument is not filed concurrently with the application, the following identifying information may be added after execution:

Serial No.: 12/338,686

Filing Date: December 18, 2008

1. The undersigned hereby agree to sign and execute any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reexamination or reissue application or in any amendments, extension of interference proceedings, or otherwise to secure the title thereto to the ASSIGNEES.

2. The undersigned agree to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property of similar agreements.

3. The undersigned agree to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the ASSIGNEES.

4. The undersigned hereby authorize and request the Commissioner of Patents in the United States to issue any and all Letters Patent resulting from said application or any division or divisions or continuing applications thereof to the said ASSIGNEES.

5. The undersigned hereby grant to the firm of Morrison & Foerster LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREBY, executed by the undersigned on the dates opposite the undersigned names.

Feb. 18, 2009  
Date

Akira Suzuki  
Name: Akira SUZUKI

Feb. 16, 2009  
Date

Katsuyuki Seki  
Name: Katsuyuki SEKI

Feb. 17, 2009  
Date

Keita Odajima  
Name: Keita ODAJIMA